

Appl. No. : 09/858,118  
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**CLEAN COPY OF PENDING CLAIMS**

59. A method of manufacturing an assembly comprising:  
combining layers of solder resist with a polyimide film to construct side bars;  
connecting said side bars to a substrate film;  
transporting said side bars and said substrate film through a manufacturing process; and  
removing said side bars after at least a portion of said manufacturing process.
60. The method of Claim 59 wherein said act of connecting said side bars comprises substantially aligning a plurality of indexing holes in said side bars with a plurality of indexing holes in said substrate film.
61. The method of Claim 59 wherein said act of connecting said side bars substantially aligns said side bars with side rails in said substrate film.
62. The method of Claim 59 further comprising the act of connecting cross bars to said substrate film.
63. The method of Claim 62 wherein said act of connecting cross bars substantially aligns said cross bars with cross rails in said substrate film.
64. The method of Claim 59 further comprising the act of interfacing said substrate film with a plurality of dies.